

Product Technical Data Sheet

Flux varnish LT-4

The product protects the printed circuit boards against oxidation and corrosion during storage. This allows for faster soldering and prevents from „cold solders”. The application method enables easy distribution of the product on boards. It can be used during production, repair, maintenance and service.

It meets the requirements of DIN 8511, F-SW-31, PN EN 29454 1.1.1.A.

Flux type: rosin
Flux type: RMA.
Drying time: 20 - 30 min

Application:

- protection of PCB against oxidation,
- applied in the production of printed circuit boards immediately after etching,
- prevents from contamination during assembly. it allows for easier soldering of heavily oxidized surfaces.

Physicochemical properties:

Parameters	UoM	Result
Density in temp. 20° C	g/cm ³	0,75
Viscosity	MPa·s	23,1

Packagings:

Volume	Type of packaging	Collective packaging	Item Code
100 ml	aerosol	4 / 20	ART.AGT-235

Warehousing:

Warehouse in closed containers in a dry, well-ventilated place, away from heat and ignition sources and direct sunlight. Do not expose to temperatures exceeding 50°C/ 122°F. Protect against electrostatic discharges.

Data contained in this document are consistent with the current state of our knowledge. They describe typical product properties and applications. However, it is up to the user to examine the suitability of this product for specific applications. We deny liability for the obtained results on the grounds that application conditions lie beyond our control.